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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Features

Technology*

- +115°C Maximum Case Temperature
- -45°C Minimum Case Temperature
- Built-in EMC Filter
- Ribbed Case Style
- 2250VDC Isolation
- Built-in EMC Filter, EN-55022 Class B

RECOM DC/DC Converter

RPP50-2412S

50 Watt 2:1 2" x 1.2" Ribbed Style Single Output

Description

ICF

The RPP50 series 2:1 input range DC/DC converters are ideal for high end industrial applications and COTS Military applications where a very wide operating temperature range of -45°C to +115°C is required. Although the case size is very compact, the converter contains a built-in EMC filter EN-55022 Class B without the need for any external components. The RPP50 is available in a ribbed case style for active cooling. They are UL-60950-1 certified.

Selection Guide							
Part	Input	Input	Output	Output	Efficiency	Max. Capacitive	
Number	Voltage Range	Current	Voltage	Current	typ.	Load	
	[VDC]	[mA]	[VDC]	[mA]	[%]	[μ F]	
RPP50-2412S	18-36	2370	12	4170	89	1000	

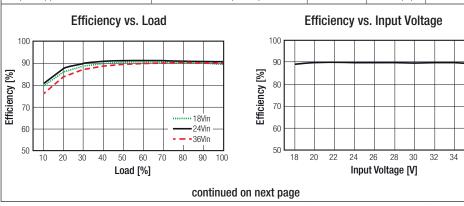
Notes:

Note1: Typical values at nominal input voltage and full load.



Specifications (measured @ ta= 25°C, nominal input voltage, full load and after warm-up)

BASIC CHARACTERISTICS							
Parameter	Condition	Min.	Тур.	Max.			
Input Voltage Range	nom. Vin= 24VDC	18VDC	24VDC	36VDC			
Transient Input Voltage	≤100ms			50VDC			
Inrush Current	with EMC Filter without EMC Filter			20A 40A			
Under Voltage Lockout	DC-DC ON DC-DC OFF	17.5VDC		17VDC			
Remote ON/OFF	ON / high logic OFF / low logic	Open, 4.5V Short, 0V		5.5V 1.2V			
Remote OFF Input Voltage	nominal input		5mA				
Start-up Time	when use CTRL function		20ms				
Internal Operating Frequency		270kHz	300kHz	330kHz			
Output Voltage Trimming			±10%				
Efficiency	typ. Vin, full load	88%	89%				
Minimum Load		0%					
Output Ripple and Noise	20MHz limited, 1µF output MLCC		50mVp-p	100mVp-p			









UL-60950-1 Certified EN-55022 Certified

* ICE Technology

ICE (Innovation in Converter Excellence) uses state-of-the-art techniques to minimise internal power dissipation and to increase the internal temperature limits to extend the ambient operating temperature range to the maximum.

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Series

Specifications (measured @ ta= 25°C, nominal input voltage, full load and after warm-up)

Trimming Output Voltage

Only the single output converters have a trim function that allows users to adjust the output voltage from +10% to -10%, please refer to the trim table that follow for details. Adjustment to the output voltage can be used with a simple fixed resistor as shown in Figures 1 and 2. A single fixed resistor can increase or decrease the output voltage depending on its connection. Resistor should be located close to the converter. If the trim function is not used, leave the trim pin open.

Trim adjustments higher than the specified range can have an adverse effect on the converter's performance and are not recommended. Excessive voltage differences between output voltage sense voltage, in conjunction with trim adjustment of the output voltage; can cause the OVP circuitry to activate. Thermal derating is based on maximum output current and voltage at the converter's output pins. Use of the trim and sense function can cause output voltages to increase, thereby increasing output power beyond the converter's specified rating. Therefore: (Vout at Pins) X (lout) \leq rated output power.

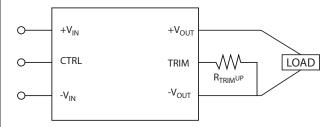


Figure 1. Trim connections to increase output voltage using fixed resistors

	Trim up resistor value (K Ω)									
Vout	1%	2%	3%	4%	5%	6%	7%	8%	9%	10%
12VDC	238.7	113.1	68.2	46.3	32.1	22.4	15.4	9.8	6.5	3.2

Note2:

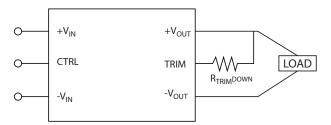


Figure 2. Trim connections to decrease output voltage using fixed resistors

	Trim down resistor value (K Ω)									
Vout	-1%	-2%	-3%	-4%	-5%	-6%	-7%	-8%	-9%	-10%
12VDC	322.2	137.2	81.1	53.1	35.5	24.0	16.0	9.7	5.0	1.3

REGULATIONS							
Parameter	Condition	Value					
Output Voltage Accuracy	50% load	±1.5% max.					
Line Voltage Regulation	low line to high line	±0.3% max.					
Load Voltage Regulation	10% to 100% load	±0.5% max.					
Transient Response	25% load step change, Δlo/Δt=2.5A/us	800μs typ.					
Transient Peak Deviation	25% load step change, Δlo/Δt=2.5A/us	±2%Vout max.					

PROTECTIONS						
Parameter	Condition	Value				
Output Power Protection (OPP)	Hiccup Mode	120% typ.				
Over Voltage Protection (OVP)	10% load	120% typ.				
Over Temperature Protection (OTP)	case temperature	120°C, auto-recovery				
Isolation Voltage	I/P to O/P, at 70% RH I/P to Case, O/P to Case	2250VDC / 1 Minute 1500VDC / 1 Minute				
Isolation Resistance	I/P to O/P , at 70% RH	100MΩ min.				
Isolation Capacitance	I/P to O/P	1500pF typ.				
Notes:						

This Power Module is not internally fused. A input fuse must be always used. Recommended Fuse: T4A



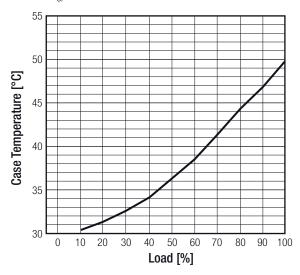
Series

Specifications (measured @ ta= 25°C, nominal input voltage, full load and after warm-up)

ENVIRONMENTAL							
Parameter	Condition		Value				
Relative Humidity			95%, non condensing				
Temperature Coefficient			±0.04% / °C max.				
Thermal Impedance	natural convection, mounting at FR4 (254x254mm) PCB	vertical horizontal	4.6°C/W 6.4°C/W				
Operating Temperature Range	start up at -45°C		-45°C to (see calculation)				
Maximum Case Temperature			+115°C				
MTBF	according to MIL-HDBK-217F (+	′	609 x 10 ³ hours 1541 x 10 ³ hours				

Derating Graph

(Ta= +25°C, natural convection, typ. Vin and vertical mounting)



Calculation

$$R_{thcase-ambient} = 4.6$$
°C/W (vertical)

$$R_{thcase-ambient} = 6.4$$
°C/W (horizontal)

$$R_{\text{thcase-ambient}} = \frac{T_{\text{case}} - T_{\text{ambient}}}{P_{\text{dissination}}}$$

$$P_{\text{dissipation}} = P_{\text{IN}} - P_{\text{OUT}} = \frac{P_{\text{OUTapp}}}{\eta} - P_{\text{OUTapp}}$$

T____ = Case Temperature

T_{ambient} = Environment Temperature

 $P_{dissipation}$ = Internal losses P_{IN} = Input Power P_{OUT} = Output Power

 η = Efficiency under given Operating Conditions

 $R_{thcase-ambient} = Thermal Impedance$

Practical Example:

Take the RPP50-2412S with 50% load. What is the maximum ambient operating temperature? Use converter vertical in application.

$$\mathrm{Eff}_{\mathrm{min}} = 89\% \ @ \ \mathrm{V}_{\mathrm{nom}}$$

$$P_{01T} = 50W$$

$$P_{OUTapp} = 50 \times 0.5 = 25W$$

$$P_{\text{dissipation}} = \frac{P_{\text{OUTapp}}}{\eta} - P_{\text{OUTapp}}$$

$$R_{th} = \ \frac{T_{casemax} - T_{ambient}}{P_{dissipation}} \quad --> 4.6 ^{\circ} \text{C/W} = \frac{-115 ^{\circ} \text{C} - T_{ambient}}{2.47 \text{W}}$$

 $\eta = \sim 91\%$ (from Eff vs Load Graph)

$$P_{\text{dissipation}} = \frac{25}{0.91} - 25 = 2.47W$$

$$T_{\text{ambientmax}} = \frac{103.6^{\circ}\text{C}}{1000}$$

continued on next page

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Series

Specifications (measured @ ta= 25°C, nominal input voltage, full load and after warm-up)

Soldering

Hand Soldering

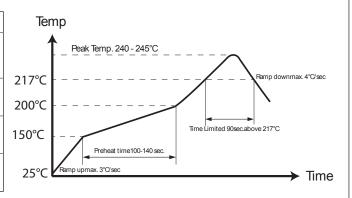
Hand Soldering is the least preferred method because the amount of solder applied, the time the soldering iron is held on the joint, the temperature of the iron and the temperature of the solder joint are variable.

The recommended hand soldering guideline is listed in Table 1. The suggested soldering process must keep the power module's internal temperature below the critical temperature of 217°C continuously.

Wave Soldering

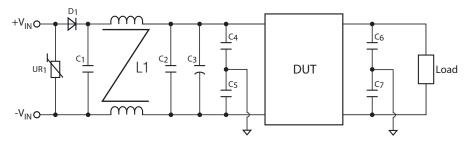
High temperature and long soldering time will result in IMC layer increasing in thickness and thereby shorten the solder joint lifetime. Therefore the peak temperature over 245°C is not suggested due to the potential reliability risk of components under continuous high-temperature. In the meanwhile, the soldering time of temperature above 217°C should be less than 90 seconds. Please refer to the soldering profile below for recommended temperature profile parameters.

Table 1 Hand-Soldering Guideline							
Parameter	Single-side Circuit Boad	Double-side Circuit Board	Multi-layers Circuit Board				
Soldering Iron Wattage	e i univi		90W				
Tip Temperature	385 ±10°C	420 ±10°C	420 ±10°C				
Soldering Time	2-6 seconds	4-10 seconds	4-10 seconds				



SAFETY AND CERTIFICATIONS							
Certificate Type (Safety)	Report Number	Standard					
Information Technology Equipment, General Requirements for Safety	E224236	UL-60950-1, 1st Edition					
Certificate Type (Environmental)	Condition	Standard / Criterion					
Information technology equipment - Radio disturbance characteristics - Limits and methods of measurement		EN55022, Class B					
ESD Immunity Test	±8kV Air Discharge, ±6kV Contact Discharge	IEC61000-4-2, Criteria B					
RF Field Strengh Susceptibility Test	10V/m	IEC61000-4-3, Criteria A					
Electrical Fast Transient Test / Burst Immunity Text	±4kV Applied	IEC61000-4-4, Criteria B					
Surge Immunity Test	±4kV Applied	IEC61000-4-5, Criteria B					
Conducted Disturbance Susceptibility Test	10V rms	IEC61000-4-6, Criteria A					
Vibration	50-150Hz, along X, Y and Z	EN60068-2-6					
Thermal Cycling (complies with MIL-STD-810F)	12 cycles	EN60068-2-14					
Shock	5g / 30ms	EN60068-2-27					

EMC Filtering - Suggestions



It is recommended to add UR1, D1 and C1 in railway application. C1, L1, C2 and C3 can be modified for required EMI standards. To meet EN61000-4-2, module case should be earth grounded. We offer independent case pin option on request, the location is upon pin 1.

Standard	UR1	D1	C1	L1	C2	C3	C4, C5, C6, C7
EN55022 Class B	MOV 1 4D0C1V	E0V / 0A	1.5µF / 250V	550μH ±20%	6.8µF / 50V	220 / 50./	0.47pF V1.Cop
EN61000-4-2, 3, 4, 5, 6	MOV 14D361K	50V / 9A	N/A	N/A	N/A	330µF / 50V	0.47nF Y1-Cap

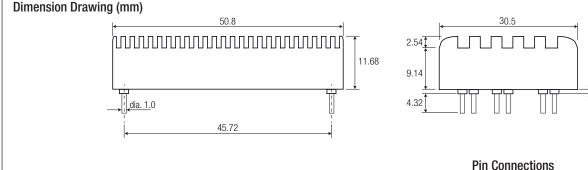


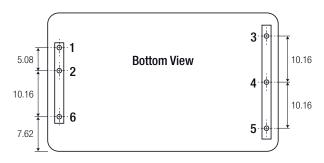
Sandoff

Series

Specifications (measured @ ta= 25°C, nominal input voltage, full load and after warm-up)

DIMENSION AND PHYSICAL CHARACTERISTICSParameterValueMaterial (3)AluminiumPackage Dimension (LxWxH)50.8 x 30.5 x 12.7mmPackage Weight39g





Pin # Single 1 +Vin 2 -Vin 3 +Vout 4 -Vout 5 Trim 6 CTRL

Tolerance: ±0.5mm

Notes:

Note3:

To ensure a good all-round electrical contact, the bottom plate is pressed firmly into place into the aluminium case. The hydraulic press can leave tooling marks and deformations to both the case and plate. The case is anodised aluminium, so there will be natural variations in the case colour and the aluminium is not scratch resistant. Any resultant marks, scratches and colour varations are cosmetic only and do not affect the operation or performance of the converters.

INSTALLATION and APPLICATION **Test Set-up** Printed Circuit Board 5μΗ 50Ω 50 Ohm termination Product LISN out DC rcvr Φ Filter Power Source 5μΗ 50Ω 1m Twisted Pair LISN Resistive Load Optional Connection to Earth Ground 50 Ohm input **FMC** Computer Reciever

PACKAGING INFORMATION						
Parameter	Туре	Value				
Packaging Dimension (LxWxH)	Tube	160.0 x 55.0 x 20.0mm				
Packaging Quantity		4pcs				
Storage Temperature Range		-55°C to +125°C				

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